



## **SPECIFICATION**

• Supplier : Samsung electro-mechanics • Samsung P/N : CL31B152KIFNFNE

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 1.5nF, 1000V, ±10%, X7R, 1206

## A. Samsung Part Number

<u>CL</u> <u>31</u> <u>B</u> <u>152</u> <u>K</u> <u>I</u> <u>F</u> <u>N</u> <u>F</u> <u>N</u> <u>E</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor		
2	Size	1206 (inch code)	L: 3.2 ± 0.15 mm	W: 1.6 ± 0.15 mm
3	Dielectric	X7R	8 Inner electrode	Ni
4	Capacitance	<b>1.5</b> nF	Termination	Cu
(5)	Capacitance	±10 %	Plating	Sn 100% (Pb Free)
	tolerance		9 Product	Product for POWER application
6	Rated Voltage	1000 V	Special	Reserved for future use
7	Thickness	1.25 ± 0.15 mm	① Packaging	Embossed Type, 7"reel(2,000ea)

## **B. Samsung Reliability Test and Judgement condition**

	Performance	Test condition	
Capacitance	Within specified tolerance	1khz±10% 1.0±0.2Vrms	
Tan δ (DF)	0.025 max.		
Insulation	More than 500Mohm⋅ <i>μ</i> F	Rated Voltage 60~120 sec.	
Resistance			
Appearance	No abnormal exterior appearance	Visual inspection	
Withstanding	No dielectric breakdown or	120% of the rated voltage	
Voltage	mechanical breakdown		
Temperature	X7R		
Characteristics	(From -55℃ to 125℃, Capacitance change should be within ±15%)		
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.	
of Termination	terminal electrode		
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)	
		with 1.0mm/sec.	
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder	
	is to be soldered newly	245±5℃, 3±0.3sec.	
		(preheating : 80~120 ℃ for 10~30sec.)	
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.	
Soldering heat	Tan δ, IR : initial spec.		

	Performance	Test condition
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)
		2hours × 3 direction (x, y, z)
Moisture	Capacitance change: within ±12.5%	With rated voltage
Resistance	Tan δ : 0.05 max	40±2℃, 90~95%RH, 500+12/-0 hours
	IR : More than 25‰· <i>μ</i> F	
High Temperature	Capacitance change: within ±12.5%	With 100% of the rated voltage
Resistance	Tan δ : 0.05 max	Max. operating temperature
	IR : More than 50MΩ· <i>μ</i> F	
	·	1000+48/-0 hours
Temperature	Capacitance change: within ±7.5%	1 cycle condition
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C
		→ Max. operating temperature → 25°C
		5 cycles test

## C. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260+0/-5  $^{\circ}$ C , 10sec. Max )

<sup>\*</sup> For the more detail Specification, Please refer to the Samsung MLCC catalogue.